

RICHARD S. KOPPEL
MARVIN E. JACOBS, P.C.
STEVEN C. PATRICK
JAYE G. HEYBL
JAMES K. DAWSON
ROBERT T. CONLEY
GREG L. MARTINEZ
Senior Counsel
MICHAEL J. RAM
LOUIS A. MOK
Patent Agent
JOSEPH COMPTON

KOPPEL, JACOBS, PATRICK & HEYBL
AN ASSOCIATION OF PROFESSIONAL LAW CORPORATIONS

555 ST. CHARLES DRIVE, SUITE 107
THOUSAND OAKS, CALIFORNIA 91360
PHONE (805) 373-0060
FAX (805) 373-0051

PATENTS
TRADEMARKS
COPYRIGHTS

September 30, 2003

22386 U.S.PTO
10/676953



Mail Stop Patent Application
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Re: LIGHT EMITTING DIODE WITH POROUS SiC SUBSTRATE
AND METHOD FOR FABRICATING
Docket No. P0284US-7

Sir:

Transmitted herewith for filing under 35 U.S.C. 111 and 37 CFR 1.53 is the patent application of Ting Li, James Ibbetson and Bernd Keller entitled LIGHT EMITTING DIODE WITH POROUS SiC SUBSTRATE AND METHOD FOR FABRICATING.

Enclosed are:

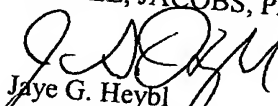
25 pages of written description, claims and abstract.
4 sheets of drawings plus 2 copies.
Declaration and Power of Attorney.
Assignment and Recordation Cover Sheet

The filing and recording fees have been calculated as shown below:

Basic Fee				
Total Claims	(28 20)	x	\$18.00	= \$750.00
Independent Claims	(5- 3)	x	\$84.00	= 144.00
Assignment				= 168.00
				<u>40.00</u>
Total Fee:				<u>\$1,102.00</u>

Our Check No. 20689 for \$1,102.00 to cover the filing and recording fees is enclosed. We authorize the Commissioner to charge (1) payment of any additional filing fees required under 37 CFR 1.16, (2) payment of any patent application processing fees under 37 CFR 1.17 associated with this communication, or (3) payment of any fees that occur during the pendency of this application (and to credit any overpayment) to Deposit Account No. 11-1580. We enclose a duplicate copy of this sheet.

Very truly yours,
KOPPEL, JACOBS, PATRICK & HEYBL


Jaye G. Heybl
Registration No. 42,661

JGH/mm
Enclosures
M/J4-P0284us-7Transmittal ltr.doc